MOSFETs Silicon N-Channel MOS

SSM6K404TU

1. Applications

- Power Management Switches
- High-Speed Switching

2. Features

(1) 1.5-V drive

(2) Low drain-source on-resistance

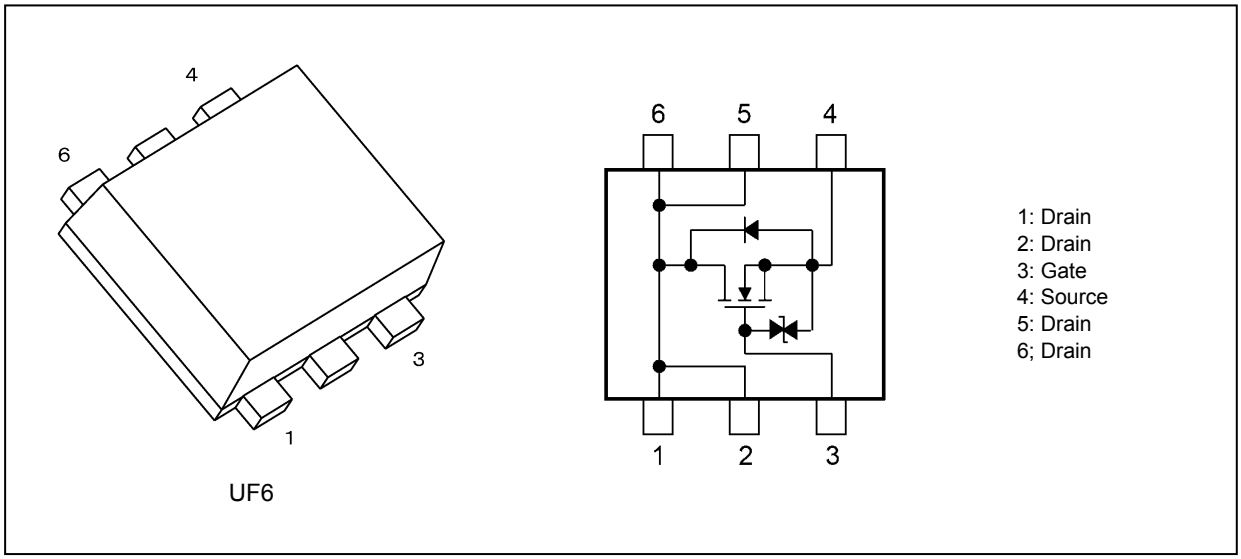
: $R_{DS(ON)}$ = 147 mΩ (max) (@V_{GS} = 1.5 V)

$R_{DS(ON)}$ = 100 mΩ (max) (@V_{GS} = 1.8 V)

$R_{DS(ON)}$ = 70 mΩ (max) (@V_{GS} = 2.5 V)

$R_{DS(ON)}$ = 55 mΩ (max) (@V_{GS} = 4.0 V)

3. Packaging and Internal Circuit



Start of commercial production

2007-01

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4. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	20	V
Gate-source voltage		V_{GSS}	±10	
Drain current (DC)	(Note 1)	I_D	3.0	A
Drain current (pulsed)	(Note 1), (Note 2)	I_{DP}	6.0	
Power dissipation	(Note 3)	P_D	500	mW
Channel temperature		T_{ch}	150	°C
Storage temperature		T_{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: Pulse width (PW) ≤ 10 ms, duty ≤ 1%

Note 3: Device mounted on an FR4 board. (25.4 mm × 25.4 mm × 1.6 mm ,Cu pad: 645 mm^2)

Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.

Note: The channel-to-ambient thermal resistance, $R_{th(ch-a)}$, and the drain power dissipation, P_D, vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

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5. Electrical Characteristics

5.1. Static Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain-source breakdown voltage		$V_{(BR)DSS}$	I_D = 1 mA, V_{GS} = 0 V	20	—	—	V
Drain-source breakdown voltage		$V_{(BR)DSX}$	I_D = 1 mA, V_{GS} = -10 V	12	—	—	
Drain cut-off current		I_{DSS}	V_{DS} = 20 V, V_{GS} = 0 V	—	—	1	μA
Gate leakage current		I_{GSS}	V_{DS} = 0 V, V_{GS} = ±10 V	—	—	±1	
Gate threshold voltage	(Note 1)	V_{th}	V_{DS} = 3 V, I_D = 1 mA	0.35	—	1.0	V
Forward transfer admittance	(Note 2)	$\|Y_{fs}\|$	V_{DS} = 3 V, I_D = 2.0 A	5.5	11	—	S
Drain-source on-resistance	(Note 2)	$R_{DS(ON)}$	I_D = 2.0 A, V_{GS} = 4.0 V	—	43	55	mΩ
			I_D = 2.0 A, V_{GS} = 2.5 V	—	53	70	
			I_D = 1.0 A, V_{GS} = 1.8 V	—	67	100	
			I_D = 0.5 A, V_{GS} = 1.5 V	—	82	147	

Note 1: Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to below (1 mA for this device). Then, for normal switching operation, $V_{GS(ON)}$ must be higher than V_{th}, and $V_{GS(OFF)}$ must be lower than V_{th}. This relationship can be expressed as: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$.
Take this into consideration when using the device.

Note 2: Pulse measurement.

5.2. Dynamic Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	—	400	—	pF
Output capacitance	C_{oss}		—	68	—	
Reverse transfer capacitance	C_{rss}		—	60	—	
Switching time (turn-on time)	t_{on}	V_{DS} = 10 V , I_D = 2.0 A, V_{GS} = 0 to 2.5 V, R_G = 4.7 Ω, Duty ≤ 1%, Input: t_r, t_f < 5 ns, Common source, T_a = 25 °C	—	14	—	ns
Switching time (turn-off time)	t_{off}		—	15	—	

5.3. Switching Time Test Circuit

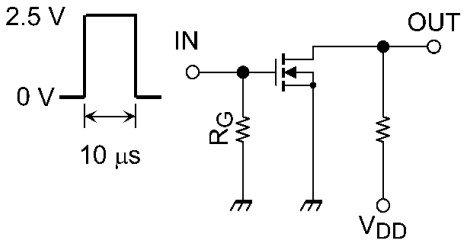


Fig. 5.3.1 Switching Time Test Circuit

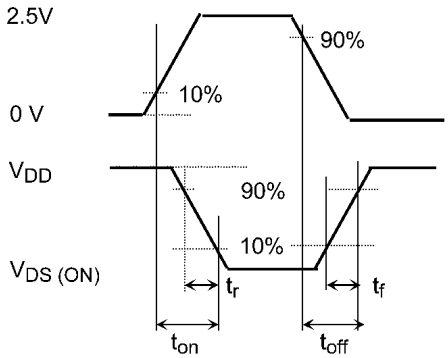


Fig. 5.3.2 Input Waveform/Output Waveform

5.4. Gate Charge Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	V_{DS} = 10 V, I_D = 3.0 A, V_{GS} = 4 V	—	5.9	—	nC
Gate-source charge	Q_{gs}		—	4.1	—	
Gate-drain charge	Q_{gd}		—	1.8	—	

5.5. Source-Drain Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage (Note 1)	V_{DSF}	I_D = -3.0 A, V_{GS} = 0 V	—	-0.85	-1.2	V

Note 1: Pulse measurement.

6. Marking

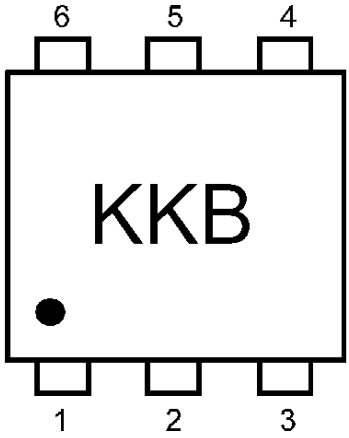


Fig. 6.1 Marking

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7. Characteristics Curves (Note)

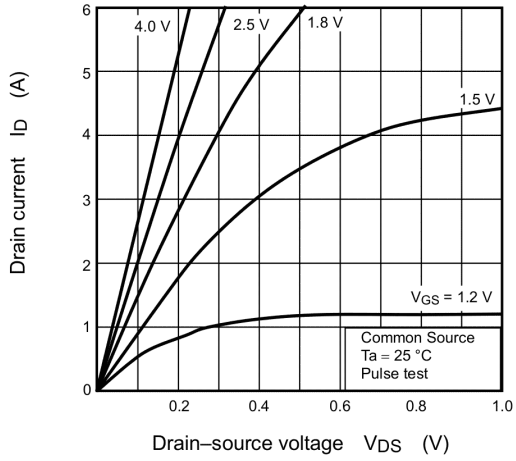


Fig. 7.1 I_D - V_{DS}

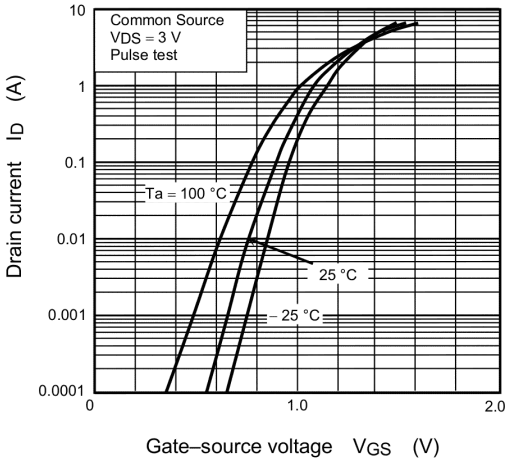


Fig. 7.2 I_D - V_{GS}

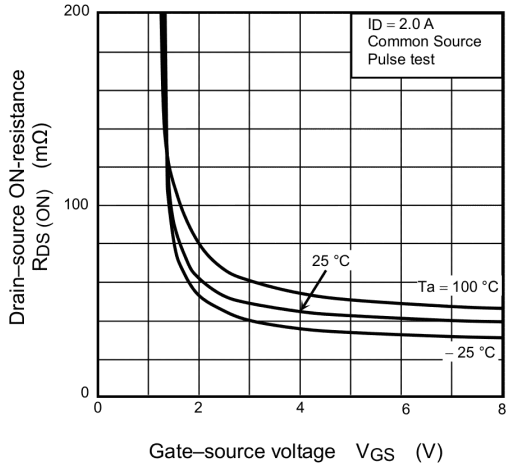


Fig. 7.3 $R_{DS(ON)}$ - V_{GS}

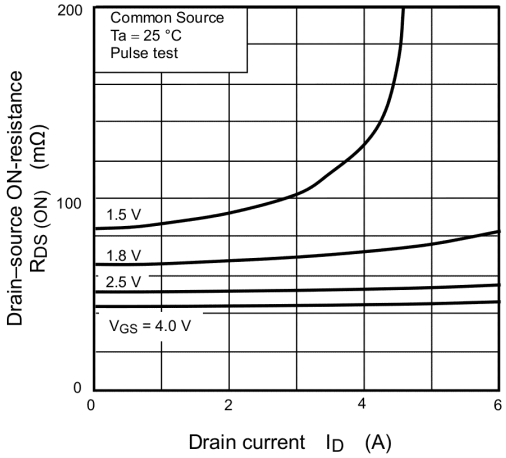


Fig. 7.4 $R_{DS(ON)}$ - I_D

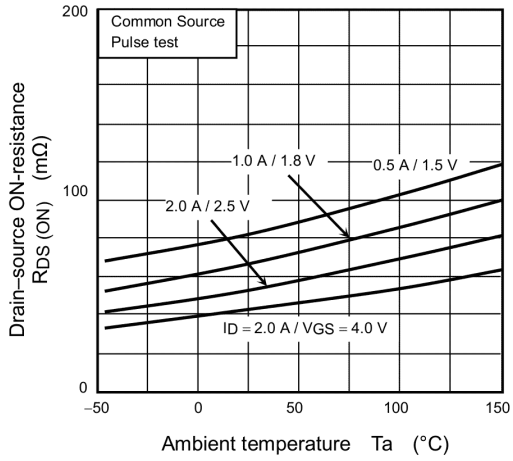


Fig. 7.5 $R_{DS(ON)}$ - T_a

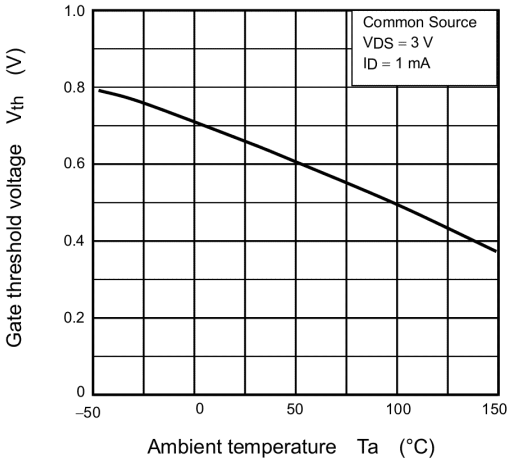


Fig. 7.6 V_{th} - T_a

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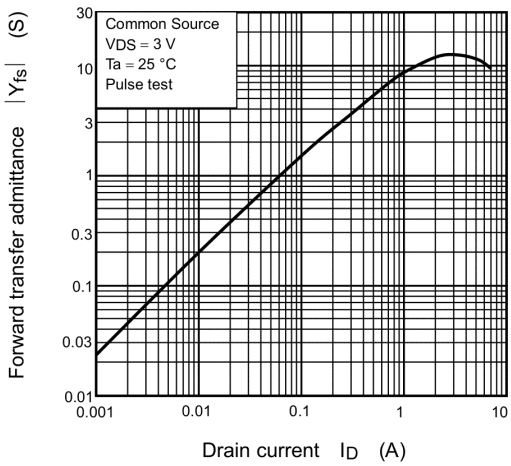


Fig. 7.7 $|Y_{fs}|$ - I_D

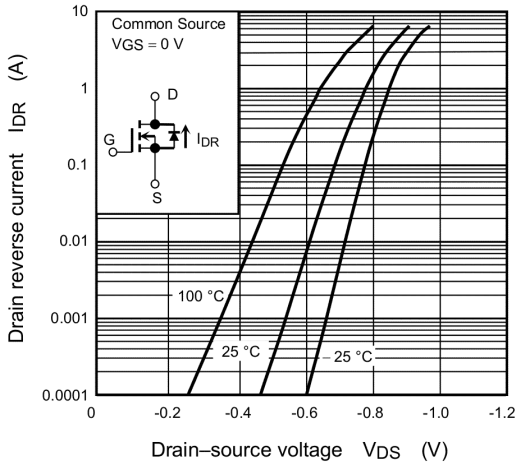


Fig. 7.8 I_{DR} - V_{DS}

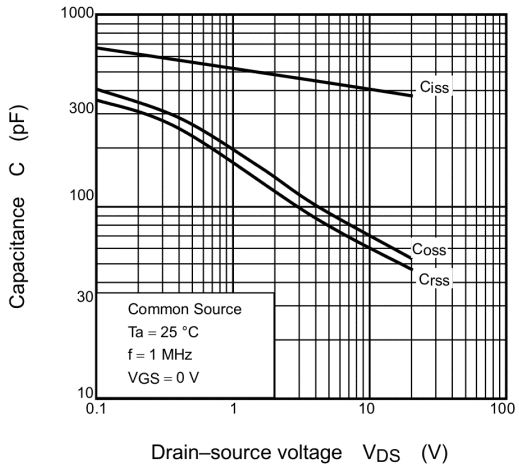


Fig. 7.9 C - V_{DS}

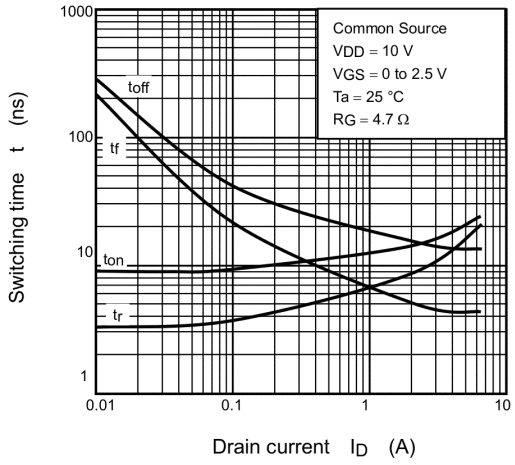


Fig. 7.10 t - I_D

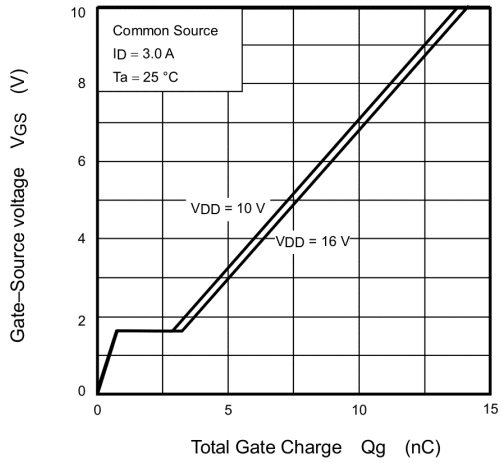


Fig. 7.11 Dynamic Input Characteristic

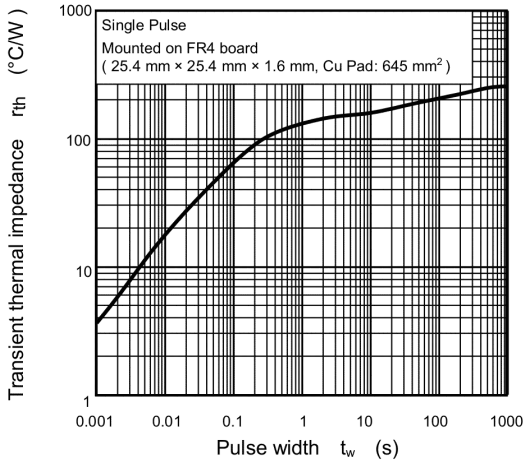


Fig. 7.12 r_{th} - t_W

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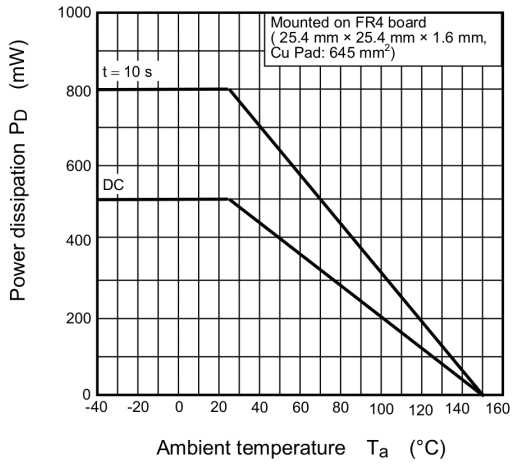


Fig. 7.13 P_D - T_a

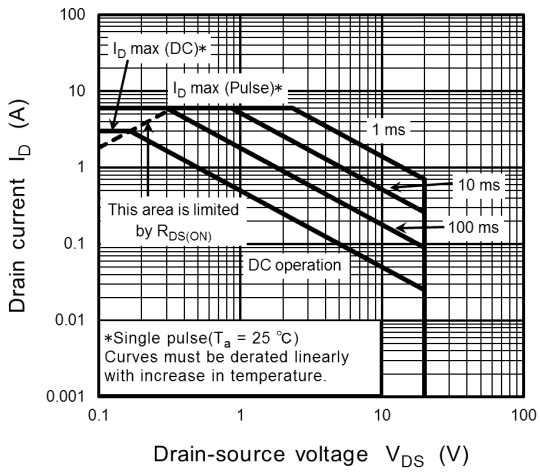


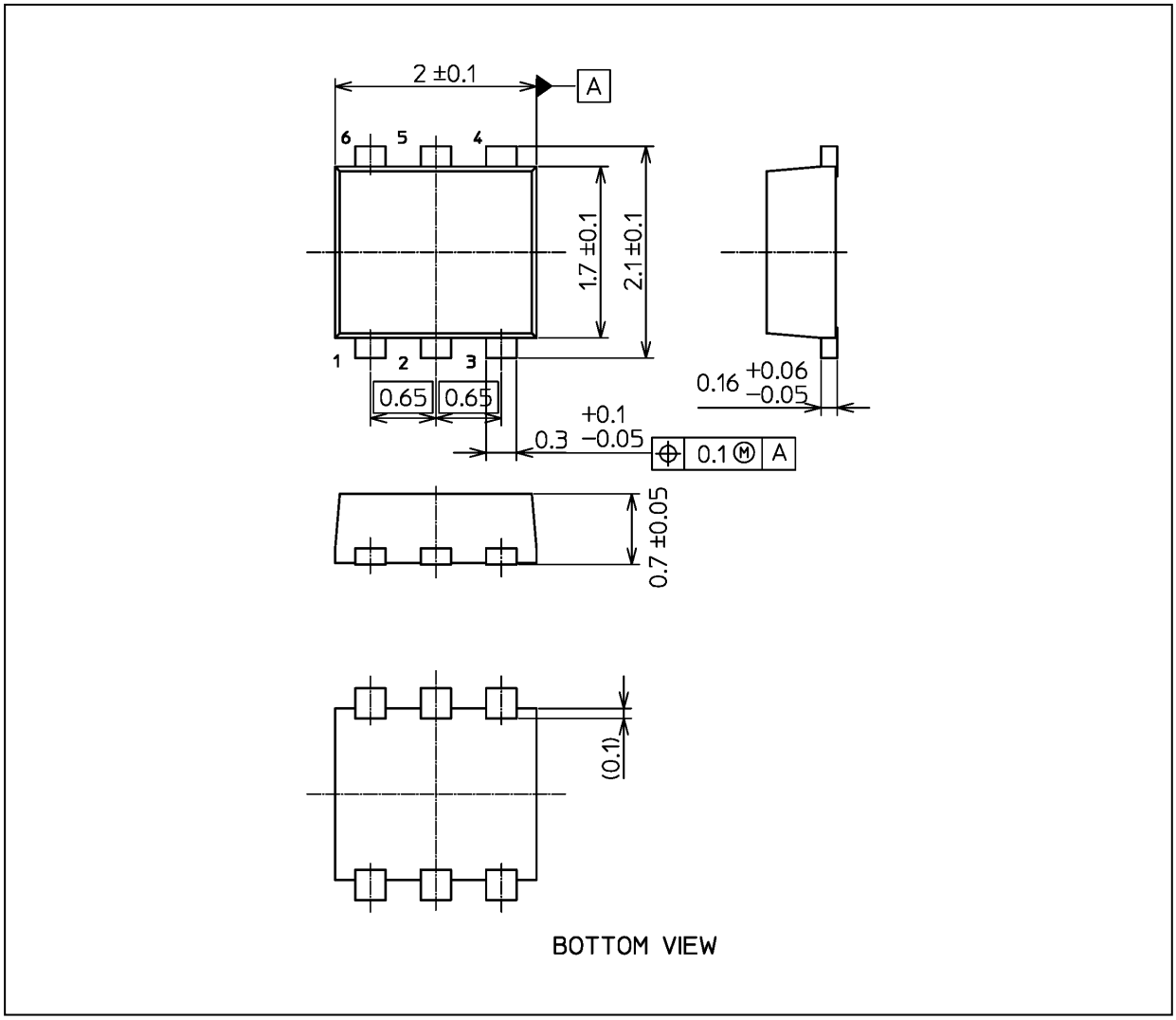
Fig. 7.14 Safe Operating Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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Package Dimensions

Unit: mm



Weight: 7.0 mg (typ.)

Package Name(s)
Nickname: UF6

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